# BLF182XR; BLF182XRS

**Power LDMOS transistor**

AMPLEON

Rev. 3 — 3 February 2016

**Product data sheet**

## 1. Product profile

### 1.1 General description

A 250 W extremely rugged LDMOS power transistor for broadcast and industrial applications in the HF to 600 MHz band.

**Table 1. Application information**

| Test signal | f | $V_{DS}$ | $P_L$ | $G_p$ | $\eta_D$ |
|---|---|---|---|---|---|
| | (MHz) | (V) | (W) | (dB) | (%) |
| pulsed RF | 108 | 50 | 250 | 28 | 75 |
| CW | 81.36 | 50 | 235 | 28 | 82 |

### 1.2 Features and benefits

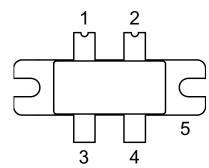
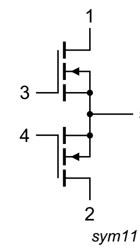
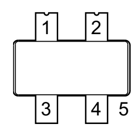
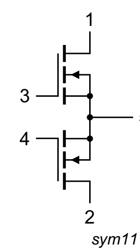
- Easy power control
- Integrated double sided ESD protection
- Excellent ruggedness
- High efficiency
- Excellent thermal stability
- Designed for broadband operation (HF to 600 MHz)
- Compliant to Directive 2002/95/EC, regarding Restriction of Hazardous Substances (RoHS)

### 1.3 Applications

- Industrial, scientific and medical applications
- Broadcast transmitter applications

## 2. Pinning information

**Table 2. Pinning**

| Pin | Description | Simplified outline | Graphic symbol |
|---|---|---|---|
| **BLF182XR (SOT1121A)** | | | |
| 1 | drain1 |  |  |
| 2 | drain2 | | |
| 3 | gate1 | | |
| 4 | gate2 | | |
| 5 | source [1] | | |
| **BLF182XRS (SOT1121B)** | | | |
| 1 | drain1 |  |  |
| 2 | drain2 | | |
| 3 | gate1 | | |
| 4 | gate2 | | |
| 5 | source [1] | | |

[1] Connected to flange.

## 3. Ordering information

**Table 3. Ordering information**

| Type number | Package | | |
|---|---|---|---|
| | Name | Description | Version |
| BLF182XR | - | flanged LDMOST ceramic package; 2 mounting holes; 4 leads | SOT1121A |
| BLF182XRS | - | earless flanged ceramic package; 4 leads | SOT1121B |

## 4. Limiting values

**Table 4. Limiting values**

*In accordance with the Absolute Maximum Rating System (IEC 60134).*

| Symbol | Parameter | Conditions | Min | Max | Unit |
|---|---|---|---|---|---|
| $V_{DS}$ | drain-source voltage | | - | 135 | V |
| $V_{GS}$ | gate-source voltage | | –6 | +11 | V |
| $T_{stg}$ | storage temperature | | –65 | +150 | °C |
| $T_j$ | junction temperature | [1] | - | 225 | °C |

[1] Continuous use at maximum temperature will affect the reliability, for details refer to the on-line MTF calculator.

## 5. Thermal characteristics

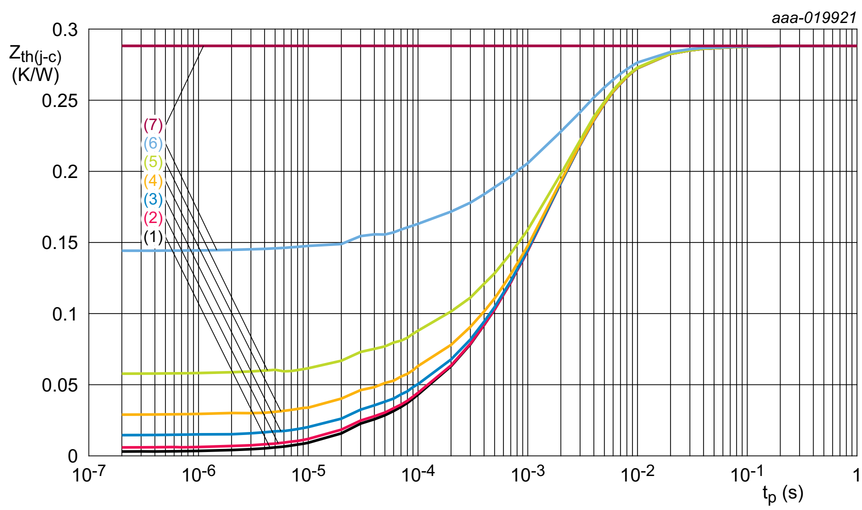
**Table 5. Thermal characteristics**

| Symbol | Parameter | Conditions | Typ | Unit |
|---|---|---|---|---|
| $R_{th(j-c)}$ | thermal resistance from junction to case | $T_j$ = 115 °C [1][2] | 0.29 | K/W |
| $Z_{th(j-c)}$ | transient thermal impedance from junction to case | $T_j$ = 150 °C; $t_p$ = 100 μs; δ = 20 % [3] | 0.088 | K/W |

[1] $T_j$ is the junction temperature.

[2] $R_{th(j-c)}$ is measured under RF conditions.

[3] See Figure 1.




(1) δ = 1 %

(2) δ = 2 %

(3) δ = 5 %

(4) δ = 10 %

(5) δ = 20 %

(6) δ = 50 %

(7) δ = 100 % (DC)

**Fig 1. Transient thermal impedance from junction to case as a function of pulse duration**

## 6. Characteristics

**Table 6. DC characteristics**

*$T_j$ = 25 °C; per section unless otherwise specified.*

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $V_{(BR)DSS}$ | drain-source breakdown voltage | $V_{GS}$ = 0 V; $I_D$ = 1.0 mA | 135 | - | - | V |
| $V_{GS(th)}$ | gate-source threshold voltage | $V_{DS}$ = 10 V; $I_D$ = 100 mA | 1.33 | 1.9 | 2.33 | V |
| $V_{GSq}$ | gate-source quiescent voltage | $V_{DS}$ = 50 V; $I_D$ = 50 mA | - | 2.1 | - | V |

**Table 6. DC characteristics** *...continued*

*$T_j$ = 25 °C; per section unless otherwise specified.*

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $I_{DSS}$ | drain leakage current | $V_{GS}$ = 0 V; $V_{DS}$ = 50 V | - | - | 1.4 | μA |
| $I_{DSX}$ | drain cut-off current | $V_{GS} = V_{GS(th)}$ + 3.75 V; $V_{DS}$ = 10 V | - | 15 | - | A |
| $I_{GSS}$ | gate leakage current | $V_{GS}$ = 11 V; $V_{DS}$ = 0 V | - | - | 140 | nA |
| $R_{DS(on)}$ | drain-source on-state resistance | $V_{GS} = V_{GS(th)}$ + 3.75 V; $I_D$ = 3.5 A | - | 0.40 | - | Ω |

**Table 7. AC characteristics**

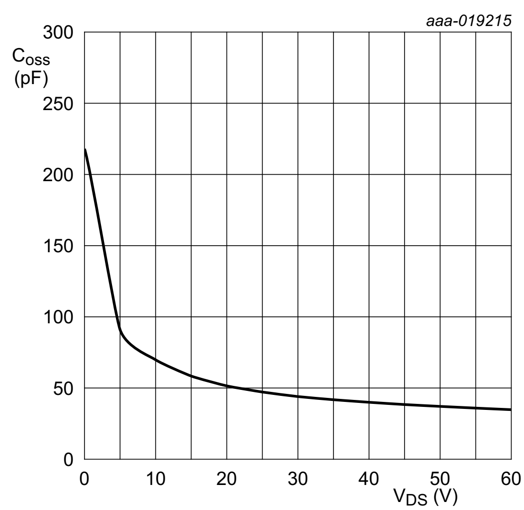
*$T_j$ = 25 °C; per section unless otherwise specified.*

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $C_{rs}$ | feedback capacitance | $V_{GS}$ = 0 V; $V_{DS}$ = 50 V; f = 1 MHz | - | 0.7 | - | pF |
| $C_{iss}$ | input capacitance | $V_{GS}$ = 0 V; $V_{DS}$ = 50 V; f = 1 MHz | - | 116 | - | pF |
| $C_{oss}$ | output capacitance | $V_{GS}$ = 0 V; $V_{DS}$ = 50 V; f = 1 MHz | - | 37 | - | pF |

**Table 8. RF characteristics**

*Test signal: pulsed RF; $t_p$ = 100 μs; δ = 20 %; f = 108 MHz; RF performance at $V_{DS}$ = 50 V; $I_{Dq}$ = 100 mA; $T_{case}$ = 25 °C; unless otherwise specified; in a class-AB production test circuit.*

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
|---|---|---|---|---|---|---|
| $G_p$ | power gain | $P_L$ = 250 W | 26.8 | 28 | - | dB |
| $RL_{in}$ | input return loss | $P_L$ = 250 W | - | −12 | −9 | dB |
| $\eta_D$ | drain efficiency | $P_L$ = 250 W | 72 | 75 | - | % |




$V_{GS}$ = 0 V; f = 1 MHz.

**Fig 2. Output capacitance as a function of drain-source voltage; typical values per section**

# 7. Test information

## 7.1 Ruggedness in class-AB operation

The BLF182XR and BLF182XRS are capable of withstanding a load mismatch corresponding to VSWR > 65 : 1 through all phases under the following conditions: $V_{DS}$ = 50 V; $I_{Dq}$ = 100 mA; $P_L$ = 250 W pulsed; f = 108 MHz.

## 7.2 Impedance information

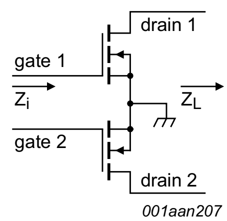



**Fig 3. Definition of transistor impedance**

**Table 9. Typical push-pull impedance**

*Simulated $Z_i$ and $Z_L$ device impedance; impedance info at $V_{DS}$ = 50 V and $P_L$ = 250 W.*

| f | $Z_i$ | $Z_L$ |
|---|---|---|
| (MHz) | (Ω) | (Ω) |
| 108 | 14.9 – 49.5j | 15.3 + 3.5j |

## 7.3 UIS avalanche energy

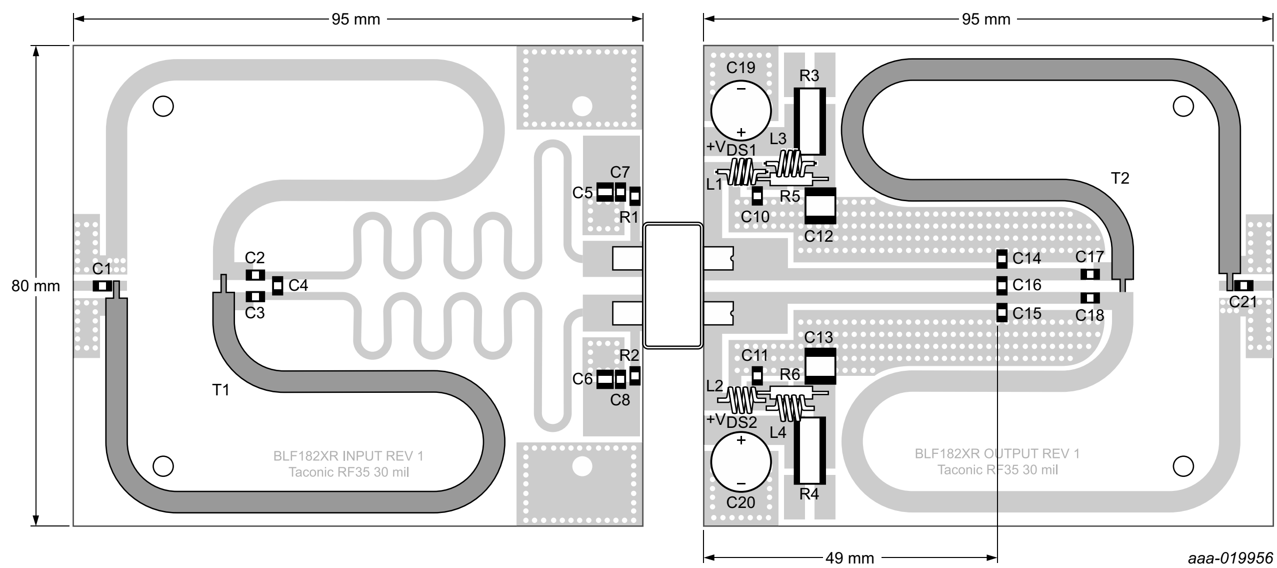
**Table 10. Typical avalanche data per section**

*$T_{amb}$ = 25 °C; typical test data; test jig without water cooling.*

| $I_{AS}$ | $E_{AS}$ |
|---|---|
| (A) | (J) |
| 8 | 2.0 |
| 9 | 1.2 |
| 10 | 0.9 |

For information see application note *AN10273*.

## 7.4 Test circuit




Printed-Circuit Board (PCB): Taconic RF-35; thickness = 0.765 mm; $\varepsilon_r$ = 3.5 F/m; thickness of copper plating = 35 μm

See Table 11 for a list of components.

**Fig 4. Component layout for class-AB production test circuit**

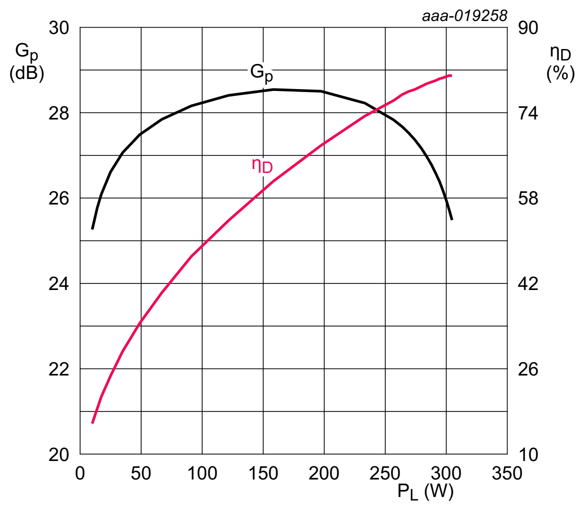
**Table 11. List of components**

*For test circuit see Figure 4.*

| Component | Description | Value | Remarks |
|---|---|---|---|
| C1 | multilayer ceramic chip capacitor | 510 pF [1] | |
| C2, C3 | multilayer ceramic chip capacitor | 220 pF [1] | |
| C4 | multilayer ceramic chip capacitor | 91 pF [1] | |
| C5, C6 | multilayer ceramic chip capacitor | 4.7 μF, 50 V | |
| C7, C8, C10, C11 | multilayer ceramic chip capacitor | 820 pF [1] | |
| C12, C13 | multilayer ceramic chip capacitor | 4.7 μF, 100 V | |
| C14, C15 | multilayer ceramic chip capacitor | 43 pF [1] | |
| C16 | multilayer ceramic chip capacitor | 6.8 pF [1] | |
| C17, C18 | multilayer ceramic chip capacitor | 130 pF [1] | |
| C19, C20 | electrolytic capacitor | 2200 μF, 64 V | |
| C21 | multilayer ceramic chip capacitor | 56 pF [1] | |
| L1, L2 | copper wire inductor | 10 turns, D = 2 mm, d = 0.5 mm | |
| L3, L4 | copper wire inductor | 6 turns, D = 2 mm, d = 0.5 mm | |
| R1, R2 | chip resistor | 4.7 kΩ | SMD 1206 |
| R3, R4 | shunt resistor | 0.01 Ω | Ohmite: FC4L110R010FER |
| R5, R6 | metal film resistor | 10 Ω, 0.6 W | |
| T1, T2 | semi rigid coax | 50 Ω, 160 mm | EZ Form: EZ-141-AL-TP-M17 |

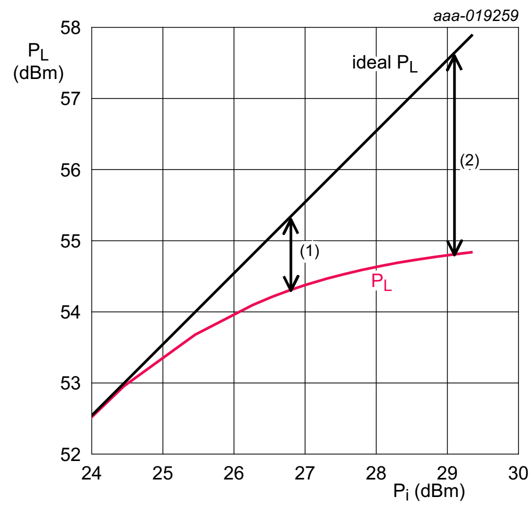
[1] American Technical Ceramics type 100B or capacitor of same quality.

### 7.5 Graphical data




$V_{DS}$ = 50 V; $I_{Dq}$ = 100 mA; f = 108 MHz; $t_p$ = 100 μs; δ = 20 %.

**Fig 5. Power gain and drain efficiency as function of output power; typical values**

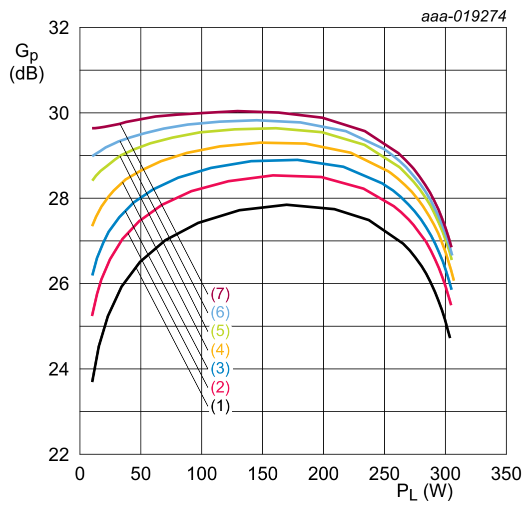



$V_{DS}$ = 50 V; $I_{Dq}$ = 100 mA; f = 108 MHz; $t_p$ = 100 μs; δ = 20 %.

(1) $P_{L(1dB)}$ = 54.3 dBm (269 W)

(2) $P_{L(3dB)}$ = 54.8 dBm (304 W)

**Fig 6. Output power as a function of input power; typical values**




$V_{DS}$ = 50 V; f = 108 MHz; $t_p$ = 100 μs; δ = 20 %.

(1) $I_{Dq}$ = 20 mA

(2) $I_{Dq}$ = 100 mA

(3) $I_{Dq}$ = 200 mA

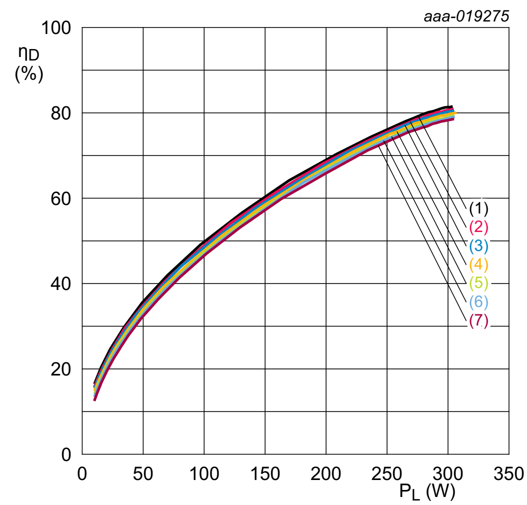
(4) $I_{Dq}$ = 400 mA

(5) $I_{Dq}$ = 600 mA

(6) $I_{Dq}$ = 800 mA

(7) $I_{Dq}$ = 1000 mA

**Fig 7. Power gain as a function of output power; typical values**




$V_{DS}$ = 50 V; f = 108 MHz; $t_p$ = 100 μs; δ = 20 %.

(1) $I_{Dq}$ = 20 mA

(2) $I_{Dq}$ = 100 mA

(3) $I_{Dq}$ = 200 mA

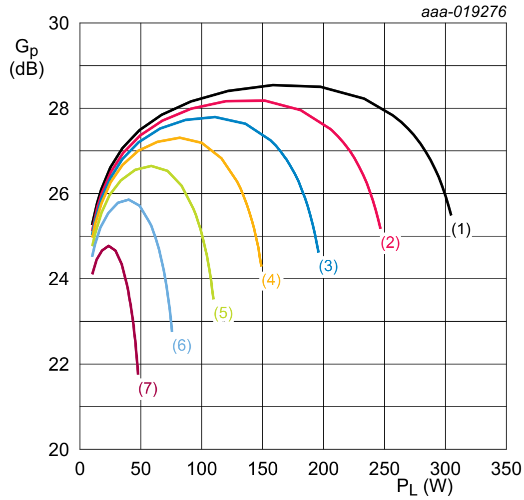
(4) $I_{Dq}$ = 400 mA

(5) $I_{Dq}$ = 600 mA

(6) $I_{Dq}$ = 800 mA

(7) $I_{Dq}$ = 1000 mA

**Fig 8. Drain efficiency as a function of output power; typical values**




$I_{Dq}$ = 100 mA; f = 108 MHz; $t_p$ = 100 μs; δ = 20 %.

(1) $V_{DS}$ = 50 V

(2) $V_{DS}$ = 45 V

(3) $V_{DS}$ = 40 V

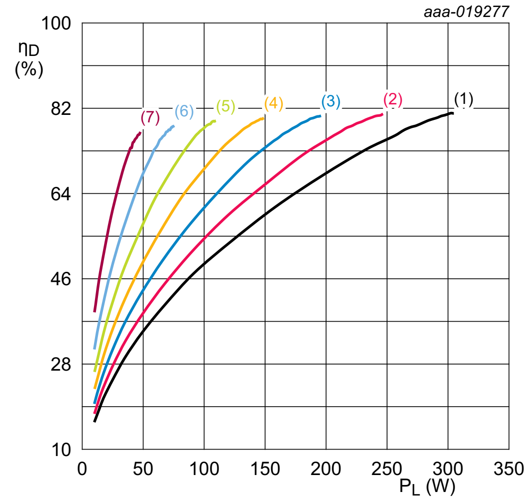
(4) $V_{DS}$ = 35 V

(5) $V_{DS}$ = 30 V

(6) $V_{DS}$ = 25 V

(7) $V_{DS}$ = 20 V

**Fig 9. Power gain as a function of output power; typical values**




$I_{Dq}$ = 100 mA; f = 108 MHz; $t_p$ = 100 μs; δ = 20 %.

(1) $V_{DS}$ = 50 V

(2) $V_{DS}$ = 45 V

(3) $V_{DS}$ = 40 V

(4) $V_{DS}$ = 35 V

(5) $V_{DS}$ = 30 V

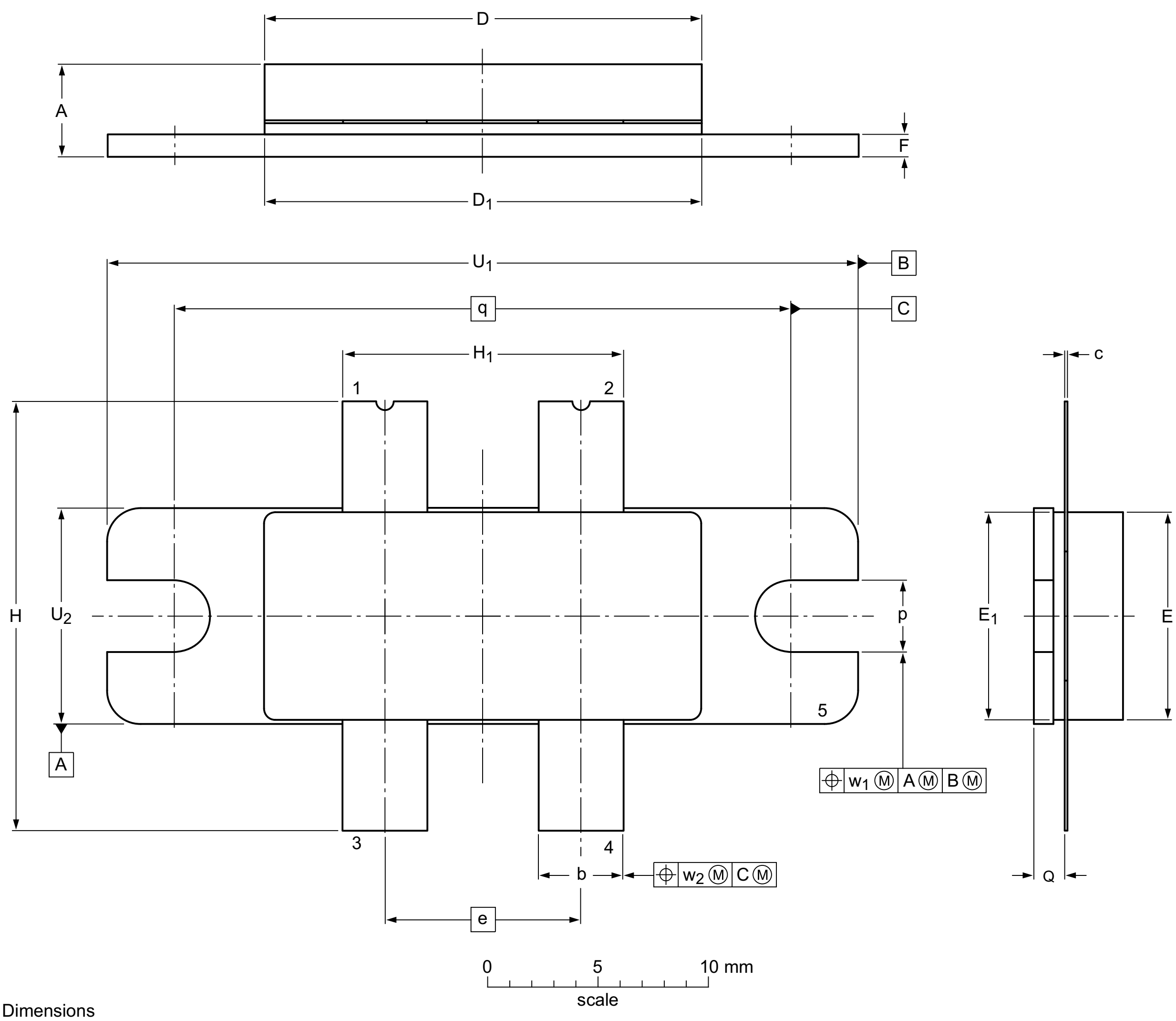
(6) $V_{DS}$ = 25 V

(7) $V_{DS}$ = 20 V

**Fig 10. Drain efficiency as a function of output power; typical values**

# 8. Package outline

**Flanged LDMOST ceramic package; 2 mounting holes; 4 leads** **SOT1121A**




Dimensions

| Unit(1) | | A | b | c | D | D1 | e | E | E1 | F | H | H1 | p | Q(2) | q | U1 | U2 | w1 | w2 |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | max | 4.75 | 3.94 | 0.18 | 20.02 | 19.96 | | 9.53 | 9.53 | 1.14 | 19.94 | 12.83 | 3.38 | 1.70 | | 34.16 | 9.91 | | |
| | nom | | | | | | 8.89 | | | | | | | | 27.94 | | | 0.25 | 0.51 |
| | min | 3.45 | 3.68 | 0.10 | 19.61 | 19.66 | | 9.27 | 9.27 | 0.89 | 18.92 | 12.57 | 3.12 | 1.45 | | 33.91 | 9.65 | | |
| inches | max | 0.187 | 0.155 | 0.007 | 0.788 | 0.786 | | 0.375 | 0.375 | 0.045 | 0.785 | 0.505 | 0.133 | 0.067 | | 1.345 | 0.39 | | |
| | nom | | | | | | 0.35 | | | | | | | | 1.1 | | | 0.01 | 0.02 |
| | min | 0.136 | 0.145 | 0.004 | 0.772 | 0.774 | | 0.365 | 0.365 | 0.035 | 0.745 | 0.495 | 0.123 | 0.057 | | 1.335 | 0.38 | | |

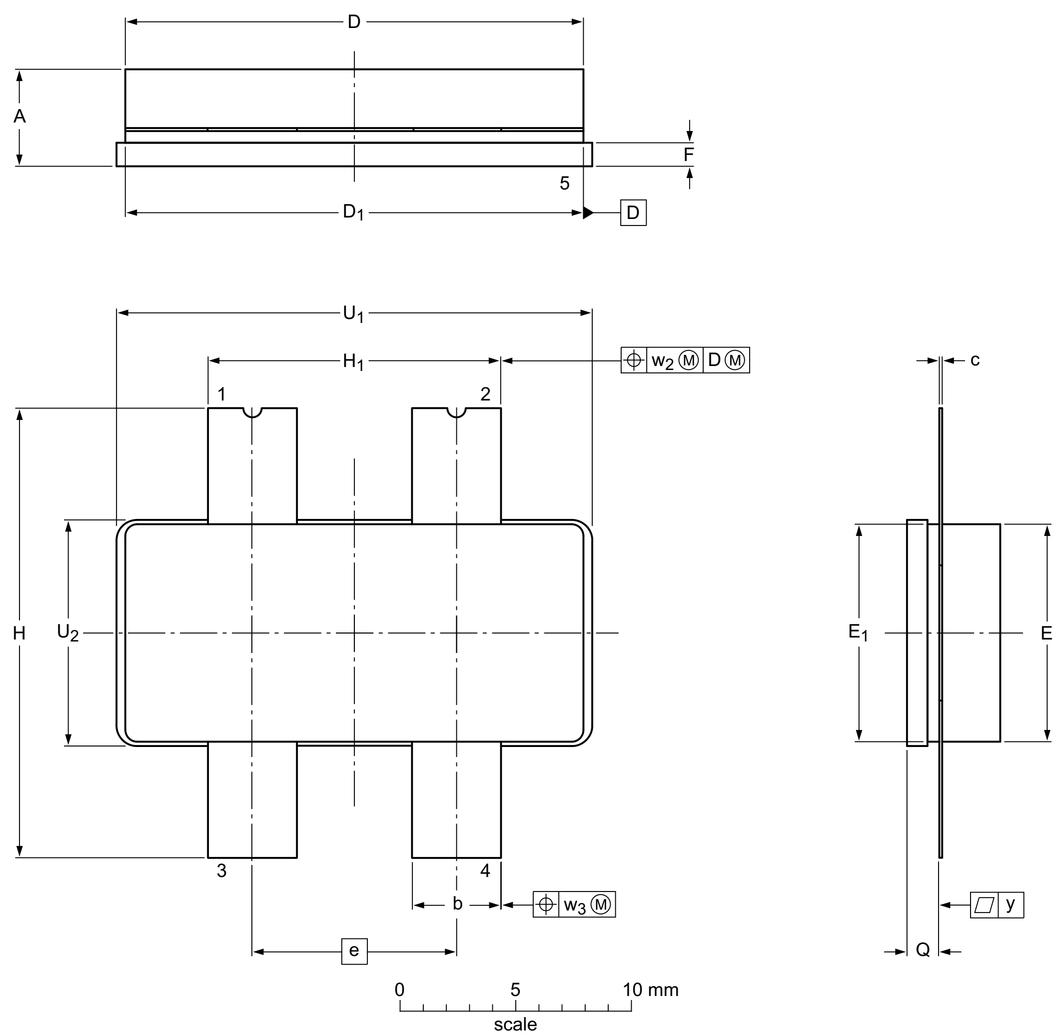
Note
1. millimeter dimensions are derived from the original inch dimensions.
2. dimension is measured 0.030 inch (0.76 mm) from the body.

*sot1121a_po*

| Outline version | References | | | | European projection | Issue date |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT1121A | | | | | | ~~09-10-12~~ 10-02-02 |

**Fig 11. Package outline SOT1121A**

**Earless flanged ceramic package; 4 leads** **SOT1121B**




Dimensions

| Unit(1) | | A | b | c | D | D1 | e | E | E1 | F | H | H1 | Q | U1 | U2 | w2 | w3 | y |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| mm | max | 4.75 | 3.94 | 0.18 | 20.02 | 19.96 | | 9.53 | 9.53 | 1.14 | 19.94 | 12.83 | 1.70 | 20.70 | 9.91 | 0.51 | 0.25 | 0.10 |
| | nom | | | | | | 8.89 | | | | | | | | | | | |
| | min | 3.45 | 3.68 | 0.08 | 19.61 | 19.66 | | 9.27 | 9.27 | 0.89 | 18.92 | 12.57 | 1.45 | 20.45 | 9.65 | | | |
| inches | max | 0.187 | 0.155 | 0.007 | 0.788 | 0.786 | | 0.375 | 0.375 | 0.045 | 0.785 | 0.505 | 0.067 | 0.815 | 0.39 | 0.02 | 0.01 | 0.004 |
| | nom | | | | | | 0.35 | | | | | | | | | | | |
| | min | 0.136 | 0.145 | 0.003 | 0.772 | 0.774 | | 0.365 | 0.365 | 0.035 | 0.745 | 0.495 | 0.057 | 0.805 | 0.38 | | | |

Note
1. millimeter dimensions are derived from the original inch dimensions.
2. dimension is measured 0.030 inch (0.76 mm) from the body.

*sot1121b_po*

| Outline version | References | | | | European projection | Issue date |
|---|---|---|---|---|---|---|
| | IEC | JEDEC | JEITA | | | |
| SOT1121B | | | | | | ~~12-06-07~~<br>15-07-21 |

**Fig 12. Package outline SOT1121B**

## 9. Handling information

**CAUTION**

This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the *ANSI/ESD S20.20*, *IEC/ST 61340-5*, *JESD625-A* or equivalent standards.

## 10. Abbreviations

**Table 12. Abbreviations**

| Acronym | Description |
|---|---|
| CW | Continuous Wave |
| ESD | ElectroStatic Discharge |
| HF | High Frequency |
| LDMOS | Laterally Diffused Metal-Oxide Semiconductor |
| LDMOST | Laterally Diffused Metal-Oxide Semiconductor Transistor |
| MTF | Median Time to Failure |
| SMD | Surface Mounted Device |
| UIS | Unclamped Inductive Switching |
| VSWR | Voltage Standing-Wave Ratio |

## 11. Revision history

**Table 13. Revision history**

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|---|---|---|---|---|
| BLF182XR_BLF182XRS v.3 | 20160203 | Product data sheet | - | BLF182XR_BLF182XRS#2 |
| Modifications: | • Table 1 on page 1: table has been updated<br>• Section 1.2 on page 1: section has been updated<br>• Table 5 on page 3: table has been updated<br>• Figure 1 on page 3: figure has been added<br>• Table 6 on page 3: table has been updated<br>• Table 8 on page 4: table has been updated<br>• Table 9 on page 5: some values have been added<br>• Table 10 on page 5: table has been updated<br>• Section 7.4 on page 6: section has been added<br>• Section 7.5 on page 7: section has been added | | | |
| BLF182XR_BLF182XRS#2 | 20150901 | Objective data sheet | - | BLF182XR_BLF182XRS v.1 |
| BLF182XR_BLF182XRS v.1 | 20150723 | Objective data sheet | - | - |

# 12. Legal information

## 12.1 Data sheet status

| Document status[1][2] | Product status[3] | Definition |
|---|---|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.ampleon.com.

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## 13. Contact information

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## 14. Contents





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